

IN THE SPECIFICATION:

Please replace paragraph [0008], [0026], [0032], and [0059] with the following amended paragraphs:

[0008] ~~The present invention generally~~ A heated substrate support and method for making the same is generally provided. In one embodiment, the heated support includes a first plate and a second plate having a heating element disposed therebetween. The heating element is biased against the top plate to provide good heat transfer therewith. In another embodiment, a heated support includes a first metallic plate coupled to a second metallic plate and sandwiching at least one guide therebetween. A resistive heating element is laterally retained by the guide relative to the first plate.

[0026] The cassette 110 generally includes walls 112, a bottom 114 and a top 116 that define an interior volume 118. A plurality of heating plates 120 are coupled to the walls 112 of the cassette 110. Four heating plates 120 are shown in the embodiment depicted in Fig. 1, however, the cassette 110 may include any number of heating plates 120. The heating plates 120 are typically arranged in a stacked, parallel orientation within the cassette 110 so that a plurality of substrates 102 may be heated or thermally regulated while being selectively stored thereon. The bottom 114 of the cassette 110 is typically ~~couple~~ coupled to a lift mechanism 108 so that a selected plate 120 may be aligned with the port 106 to facilitate substrate transfer.

[0032] One or more channels 210 are generally provided in at least one of the plates 202, 204 to house the heating element 206. In the embodiment depicted in Fig. 2A, the channel 210 is formed in the ~~[[a]]~~ first side 212 of second plate 204. The channel 210 is generally configured to receive the resistive heating element 206 and maintain the lateral position of the heating element 206 within a predetermined tolerance after coupling the first and second plate 202, 204.

[0059] A heated substrate support and method for making the same is generally provided. In one embodiment, a heated support includes ~~[[a]]~~ first and second plates having a heating element disposed therebetween. The heating element is biased against the first plate to provide good heat transfer therewith. In another embodiment, a

heated support includes a first metallic plate coupled to a second metallic plate and sandwiching at least one guide therebetween. A resistive heating element is laterally retained by the guide relative to the first plate. In another aspect of the invention, a heating chamber for heating a substrate is provided. In one embodiment, the heating chamber includes walls defining an interior volume and a plurality of heated support plates coupled to the walls. The support plates are generally stacked parallel to each other within the interior volume. A heating element is urged against each first support plate.